

**Pixel Hybrid Photon Detectors** for the RICH Detectors of LHCb



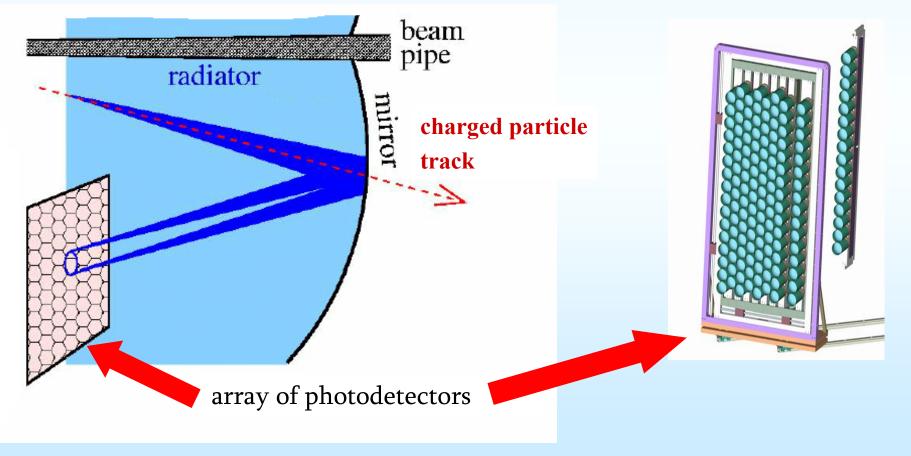
IWORID 27<sup>th</sup> July 2004 Glasgow

- The RICH detectors of LHCb
- pixel-HPD Design
- pixel-HPD Laboratory & Testbeam Results

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## Particle Identification for LHCb - Cherenkov Radiation

- LHCb is a B physics detector planned for the Large Hadron Collider, currently being built at CERN
- Particle identification is important for planned physics studies at LHCb
- Two <u>Ring</u> Imaging <u>CH</u>erenkov detectors are needed for particle identification



#### **Photodetector Specifications**

Need to detect single photons with a wavelength from 200-600 nm

#### The **photodetector** must combine:

- single photon sensitivity
  - single photoelectron detection efficiency better than 85%
- granularity of 2.5mm x 2.5mm
- high active-to-total area ratio ~70%
- high signal-to-noise ratio
- fast readout time resolution better than 25ns

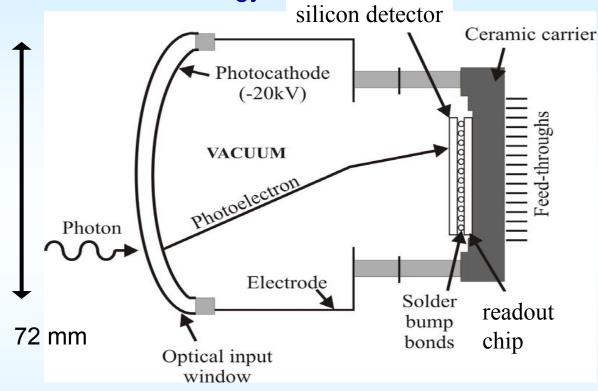
and survive:

- a radiation dose of 3krad per year
- a magnetic field of < 2.5 milliTesla

## solution – development of pixel <u>Hybrid</u> <u>Photon</u> <u>Detector</u>

## Pixel Hybrid Photon Detectors – Principles & Design

pixel-HPDs combine in a single device vacuum photo-cathode technology and solid-state technology



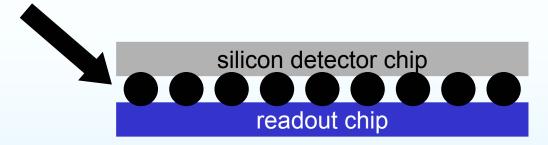
The readout chip is fully encapsulated in the device

- Peak quantum efficiencies reach 25 % at ~270 nm wavelength
- pixellated silicon detector

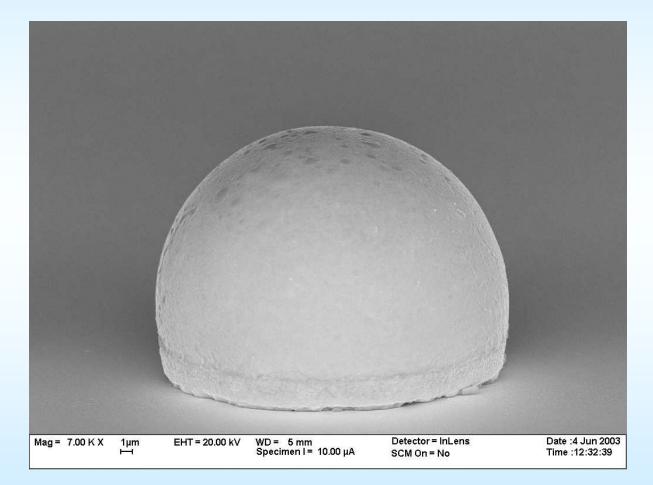
each pixel bump-bonded to individual channel on readout chip
 All parts of the pixel-HPD are compatible with the demanding bake-out
 cycle required to produce the high quality photocathode

1. silicon detector bump bonded to readout chip - anode

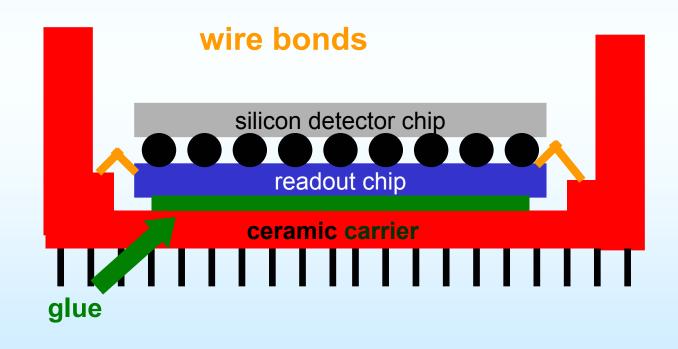
bump bonds



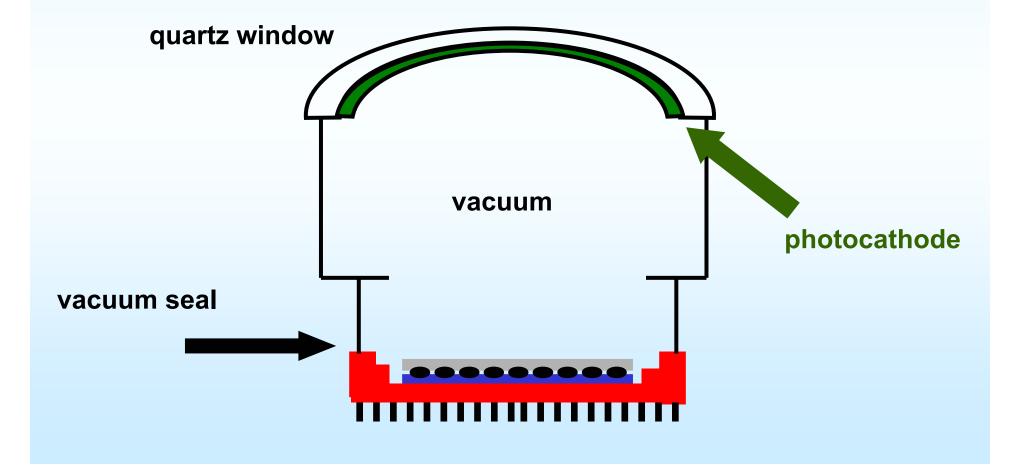
1. silicon detector bump bonded to readout chip - anode



- 1. silicon detector bump bonded to readout chip anode
- 2. anode glued to ceramic carrier and wire bonded packaged anode



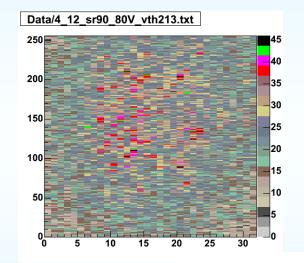
- 1. silicon detector bump bonded to readout chip anode
- 2. anode glued to ceramic carrier and wire bonded packaged anode
- 3. Vacuum bakeout cycle temperature reaches ~300°C
- 4. Photocathode processing and sealing of pixel-HPD tube to carrier



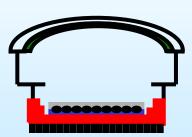
#### Testing at each stage of process



Bare readout chip on wafer of 71 chips

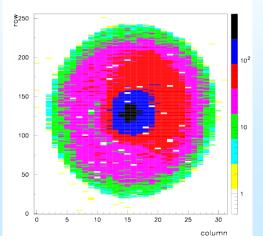






pixel-HPD after bakeout & vacuum encapsulation

Packaged anode



## Laboratory Testing of Pixel-HPD prototypes

Pulsed low intensity LED used to determine tube characteristics some important numbers:

# Single photoelectron detection efficiency

- measured to be ~88%
- LHCb specification 85%



#### **Discriminator Threshold**

- Threshold scan performed by varying size of test pulse hence amount of charge injected
- Provides information on threshold and noise distribution across pixels
- Typical results: mean threshold ~1250 e-, sigma ~ 100 e-
- Specifications minimum threshold 2000 e-, sigma 300 e-

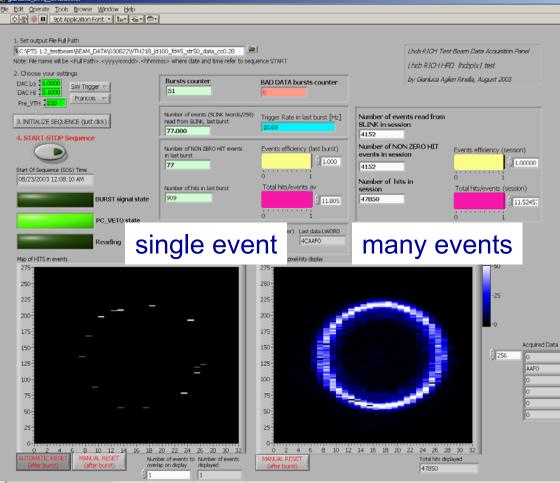
#### Testbeam

- 10 GeV pion/electron beam
- air filled RICH vessel prototype
- Cherenkov rings focused on a pixel-HPD
- Two 40MHz prototypes found to be fully functional confirmed more precise lab measurements
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snapshot of online DAQ

Beam restricted to electrons

Cherenkov angle resolution and photon detection efficiency measured



#### **Testbeam Results**

#### **Cherenkov Angle Resolution**

- Fit to hits from all events from single run electrons only
- error mainly due to uncertainty on individual electron tracks in beam

tube	Cherenkov angle (mrad)	
	Expected	observed
HPD#1	23.7	23.6 (± 1.0)
HPD#2	23.7	22.8 (± 1.2)

#### **Detection efficiency**

- Confirms lab measurements
  - lab result ~88%
- error contributions mirror reflectivity, pixel-HPD quantum efficiency, refractive index and absorption curve of air

tube	Detection efficiency	
	(%)	
HPD#1	87 ± 5.3	
HPD#2	83 ± 5.2	

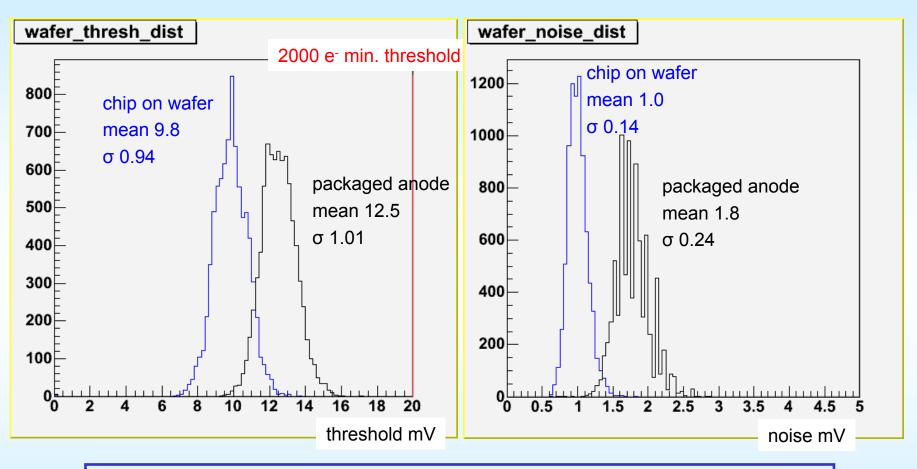
Fulfils LHCb requirement of 85%

## Conclusions & Future Plans

- A pixel Hybrid Photon Detector has been developed that satisfies the stringent requirements of the LHCb Ring Imaging CHerenkov detectors
- Single photon sensitivity, a high active-to-total area ratio and 25ns time resolution have been achieved
- Laboratory tests combined with test beam results have proven the performance of the pixel-HPDs
- High occupancy and ageing tests carried out no degradation in performance
  - more tests planned
- Sucessful recent testbeam, closer to final RICH system
  - aerogel radiator and array of three pixel-HPDs
  - paper will be published with results
- Testbeam planned for the end of the year
  - close packed array of preproduction pixel-HPDs
  - DAQ based on prototype of LHCb readout electronics chain
- Production of ~500 pixel-HPDs underway

## reserve slides

#### Testing – results for threshold scan bare chip vs bump boned anode assembly



Average threshold has moved to higher value - since more noise with packaged anode Threshold still below specification limit of 2000 e<sup>-</sup> Threshold spread specification limit is 300 e<sup>-</sup>

## Ion Feedback & Dark Counts

example of test beam measurement

#### Ion Feedback

- Ionisation of residual gas molecules in pixel-HPD tube can cause background
- ionised molecule accelerated to cathode releases bunch of e- which are accelerated to anode
- ion feedback rate measured in testbeam to be less than 0.5%
  - => excellent vacuum quality

#### **Dark Counts**

- Thermal emission from cathode produces background signal
- average rate at 25 °C measured to be ~1kHz/cm<sup>2</sup>

#### Aerogel Testbeam – details of set-up

- The furthest upstream RICH detector will have both a CF<sub>4</sub> and an aerogel radiator
- The performance of aerogel was invesigated in a testbeam, using three HPDs as photodetectors
- Analysis of the results is ongoing paper in preparation

